COPY

PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Hirokazu MIYAZAKI

Serial No. (unknown)

Filed herewith

MOUNTING STRUCTURE OF SEMICONDUCTOR DEVICE AND MOUNTING METHOD THEREOF

CLAIM FOR FOREIGN PRIORITY UNDER 35 U.S.C. 119 AND SUBMISSION OF PRIORITY DOCUMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Attached hereto is a certified copy of applicant's corresponding patent application filed in Japan on February 25, 2000, under No. 49904/2000.

Applicant herewith claims the benefit of the priority filing date of the above-identified application for the above-entitled U.S. application under the provisions of 35 U.S.C. 119.

Respectfully submitted,

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February 21, 2001

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別紙添付の書類に記載されている事項は下記の出願書類に記載されてる事項と同一であることを証明する。

This is to certify that the annexed is a true copy of the following application as filed in this Office.

計願年月日 Mate of Application:

2000年 2月25日

願番号

特願2000-049904

願人 wicant (s):

日本電気株式会社

2000年11月17日

特 許 庁 長 官 Commissioner, Patent Office



